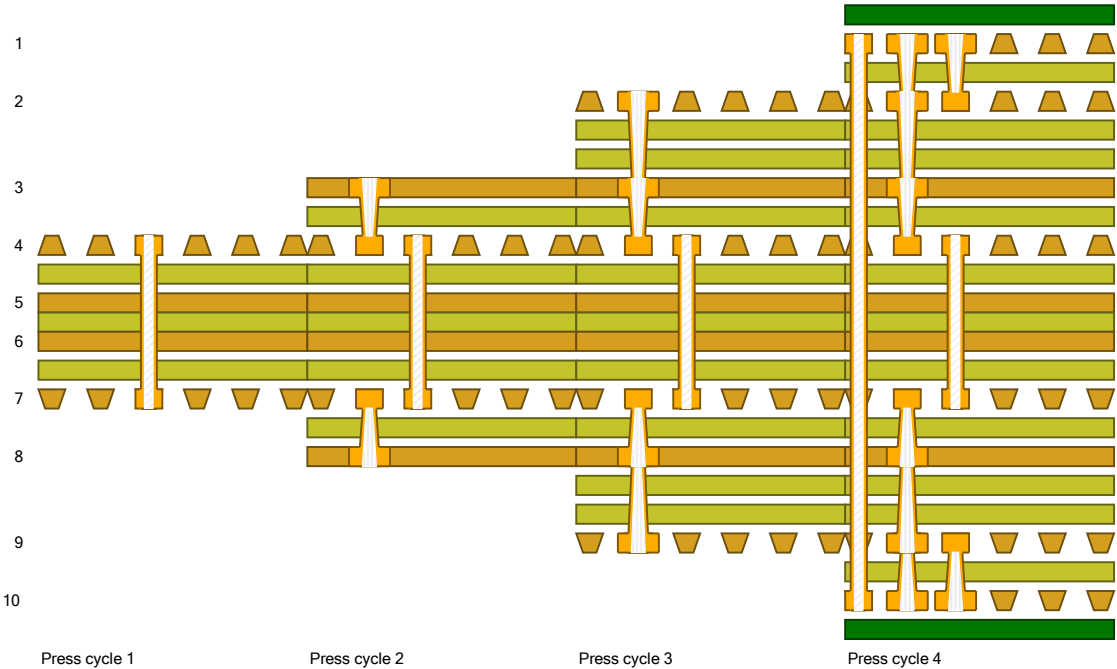




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Layer	Stack up	Description	Copper Layer Type	Base Thickness	Processed Thickness	Resin Content	εr	Loss Tangent	Impedance ID	
4		Copper Foil	Signal	17.780	35.560					
		PrePreg 3113		100.000	100.000	53.000	4.200	0.0195		
5			Plane	35.000	35.000					
		FR4 Core		100.000	100.000	53.000	4.200	0.0195		
6			Plane	35.000	35.000					
		PrePreg 3113		100.000	100.000	53.000	4.200	0.0195		
7		Copper Foil	Signal	17.780	35.560					
Copper Thickness = 141.120 Dielectric Thickness = 300.000 Solder Mask Thickness = 0.000 Stack Up Thickness = 441.120 Stack Up Thickness with Soldermask = 441.120 Stack Up Cost = 8.00										

Drill Image	1st Layer	2nd Layer	Column Position	Drill Type	
	4	7	3	Mechanical PTH	

Supplier	Supplier Description	Description	Type	Stock Number	Stack Quantity	Unit Cost	Stack Cost	Total Quantity	Total Cost	
Polar Samples	FO/001	Copper Foil	Copper	100-001	2	0.50	1.00	2	1.00	
Polar Samples	PP/007	PrePreg 1651	Dielectric	300-004	6	1.00	6.00	6	6.00	
Polar Samples	PP/002	PrePreg 3080	Dielectric	300-002	3	1.00	3.00	3	3.00	
Polar Samples	PP/001	PrePreg 1080	Dielectric	300-001	2	1.00	2.00	2	2.00	
Polar Samples	FO/002	Copper Foil	Copper	100-002	2	2.00	4.00	2	4.00	
Polar Samples	PP/003	PrePreg 3113	Dielectric	300-003	2	1.00	2.00	2	2.00	
Polar Samples	CO/008	FR4 Core	FR4	400-008	1	2.00	2.00	1	2.00	
							23.00		23.00	

No. of Panels = 1 | Circuits Per Panel = 1 | Price Per Circuit = 23.00 |
Notes

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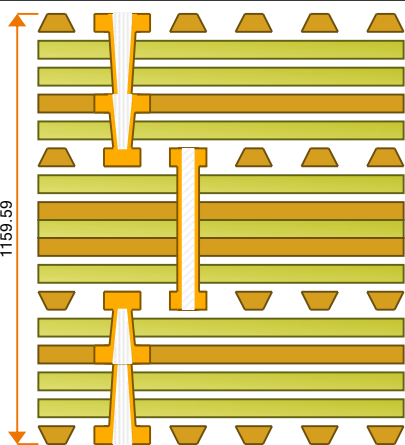
Layer	Stack up	Description	Copper Layer Type	Base Thickness	Processed Thickness	Resin Content	εr	Loss Tangent	Impedance ID	
3		Copper Foil	Plane	35.560	53.340					
		PrePreg 1651		125.000	125.000	47.000	4.200	0.0195		
4		Copper Foil	Signal	17.780	35.560					
		PrePreg 3113		100.000	100.000	53.000	4.200	0.0195		
5			Plane	35.000	35.000					
		FR4 Core		100.000	100.000	53.000	4.200	0.0195		
6			Plane	35.000	35.000					
		PrePreg 3113		100.000	100.000	53.000	4.200	0.0195		
7		Copper Foil	Signal	17.780	35.560					
		PrePreg 1651		125.000	125.000	47.000	4.200	0.0195		
8	Copper Foil	Plane	35.560	53.340						
Copper Thickness = 247.800 Dielectric Thickness = 550.000 Solder Mask Thickness = 0.000 Stack Up Thickness = 797.800 Stack Up Thickness with Soldermask = 797.800 Stack Up Cost = 20.00										

Drill Image	1st Layer	2nd Layer	Column Position	Drill Type	
	3	4	2	Laser PTH	
	4	7	3	Mechanical PTH	
	8	7	2	Laser PTH	

Supplier	Supplier Description	Description	Type	Stock Number	Stack Quantity	Unit Cost	Stack Cost	Total Quantity	Total Cost	
Polar Samples	FO/001	Copper Foil	Copper	100-001	2	0.50	1.00	2	1.00	
Polar Samples	PP/007	PrePreg 1651	Dielectric	300-004	6	1.00	6.00	6	6.00	
Polar Samples	PP/002	PrePreg 3080	Dielectric	300-002	3	1.00	3.00	3	3.00	
Polar Samples	PP/001	PrePreg 1080	Dielectric	300-001	2	1.00	2.00	2	2.00	
Polar Samples	FO/002	Copper Foil	Copper	100-002	2	2.00	4.00	2	4.00	
Polar Samples	PP/003	PrePreg 3113	Dielectric	300-003	2	1.00	2.00	2	2.00	
Polar Samples	CO/008	FR4 Core	FR4	400-008	1	2.00	2.00	1	2.00	
							23.00		23.00	

No. of Panels = 1 | Circuits Per Panel = 1 | Price Per Circuit = 23.00 |
Notes

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Layer	Stack up	Description	Copper Layer Type	Base Thickness	Processed Thickness	Resin Content	εr	Loss Tangent	Impedance ID
2		Copper Foil	Signal	17.780	35.560				
		PrePreg 3080		75.000	75.000	60.000	4.200	0.0195	
		PrePreg 1080		65.670	65.670	60.000	4.200	0.0195	
3		Copper Foil	Plane	35.560	53.340				
		PrePreg 1651		125.000	125.000	47.000	4.200	0.0195	
4		Copper Foil	Signal	17.780	35.560				
		PrePreg 3113		100.000	100.000	53.000	4.200	0.0195	
5			Plane	35.000	35.000				
		FR4 Core		100.000	100.000	53.000	4.200	0.0195	
6			Plane	35.000	35.000				
		PrePreg 3113		100.000	100.000	53.000	4.200	0.0195	
7		Copper Foil	Signal	17.780	35.560				
		PrePreg 1651		125.000	125.000	47.000	4.200	0.0195	
8		Copper Foil	Plane	35.560	53.340				
		PrePreg 3080		75.000	75.000	60.000	4.200	0.0195	
		PrePreg 3080		75.000	75.000	60.000	4.200	0.0195	
9		Copper Foil	Signal	17.780	35.560				

Copper Thickness = 318.920 | Dielectric Thickness = 840.670 | Solder Mask Thickness = 0.000 | Stack Up Thickness = 1159.590 | Stack Up Thickness with Soldermask = 1159.590
Stack Up Cost = 28.00

Drill Image	1st Layer	2nd Layer	Column Position	Drill Type
	2	3	2	Laser PTH
	3	4	2	Laser PTH
	4	7	3	Mechanical PTH
	8	7	2	Laser PTH
	9	8	2	Laser PTH

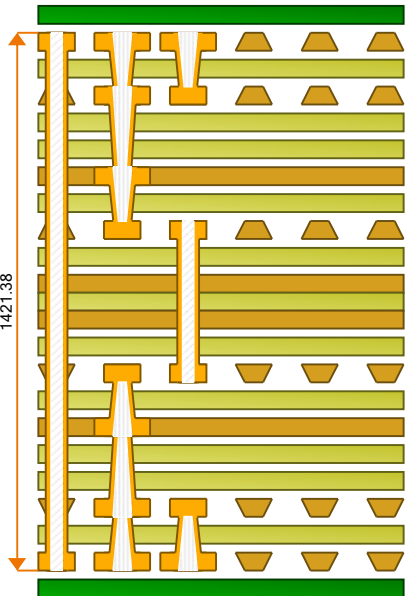
Supplier	Supplier Description	Description	Type	Stock Number	Stack Quantity	Unit Cost	Stack Cost	Total Quantity	Total Cost
Polar Samples	FO/001	Copper Foil	Copper	100-001	2	0.50	1.00	2	1.00
Polar Samples	PP/007	PrePreg 1651	Copper Dielectric	300-004	6	1.00	6.00	6	6.00
					3	1.00	3.00	3	3.00

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Supplier	Supplier Description	Description	Type	Stock Number	Stack Quantity	Unit Cost	Stack Cost	Total Quantity	Total Cost	
Polar Samples	PP/002	PrePreg 3080	Dielectric	300-002	3	1.00	3.00	3	3.00	
Polar Samples	PP/001	PrePreg 1080	Dielectric	300-001	2	1.00	2.00	2	2.00	
Polar Samples	FO/002	Copper Foil	Copper	100-002	2	2.00	4.00	2	4.00	
Polar Samples	PP/003	PrePreg 3113	Dielectric	300-003	2	1.00	2.00	2	2.00	
Polar Samples	CO/008	FR4 Core	FR4	400-008	1	2.00	2.00	1	2.00	
							23.00		23.00	

No. of Panels = 1 | Circuits Per Panel = 1 | Price Per Circuit = 23.00 |
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Layer	Stack up	Description	Copper Layer Type	Base Thickness	Processed Thickness	Resin Content	ϵ_r	Loss Tangent	Impedance ID	
1		Copper Foil	Signal	17.780	35.560		4.000	0.0000		
2		PrePreg 1651		125.000	125.000	47.000	4.200	0.0195		
3		Copper Foil	Signal	17.780	35.560		4.200	0.0195		
4		PrePreg 3080		75.000	75.000	60.000	4.200	0.0195		
5		PrePreg 1080		65.670	65.670	60.000	4.200	0.0195		
6		Copper Foil	Plane	35.560	53.340		4.200	0.0195		
7		PrePreg 1651		125.000	125.000	47.000	4.200	0.0195		
8		Copper Foil	Signal	17.780	35.560		4.200	0.0195		
9		PrePreg 3113		100.000	100.000	53.000	4.200	0.0195		
10		FR4 Core	Plane	35.000	35.000	53.000	4.200	0.0195		
11		PrePreg 3113		100.000	100.000	53.000	4.200	0.0195		
12		Copper Foil	Signal	17.780	35.560		4.200	0.0195		
13		PrePreg 1651		125.000	125.000	47.000	4.200	0.0195		
14		Copper Foil	Plane	35.560	53.340		4.200	0.0195		
15		PrePreg 3080		75.000	75.000	60.000	4.200	0.0195		
16		PrePreg 3080		75.000	75.000	60.000	4.200	0.0195		
17		Copper Foil	Signal	17.780	35.560		4.200	0.0195		
18		PrePreg 1080		65.670	65.670	60.000	4.200	0.0195		
19		Copper Foil	Signal	17.780	35.560		4.000	0.0000		
20				25.400			4.000	0.0000		

Copper Thickness = 390.040 | Dielectric Thickness = 1031.340 | Solder Mask Thickness = 50.800 | Stack Up Thickness = 1421.380 | Stack Up Thickness with Soldermask = 1472.180
Stack Up Cost = 32.50

Drill Image	1st Layer	2nd Layer	Column Position	Drill Type	
	1	2	2	Laser PTH	
	1	2	3	Laser PTH	
	1	10	1	Mechanical PTH	
	2	3	2	Laser PTH	
	3	4	2	Laser PTH	

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Drill Image	1st Layer	2nd Layer	Column Position	Drill Type	
	4	7	3	Mechanical PTH	
	8	7	2	Laser PTH	
	9	8	2	Laser PTH	
	10	9	3	Laser PTH	
	10	9	2	Laser PTH	

Supplier	Supplier Description	Description	Type	Stock Number	Stack Quantity	Unit Cost	Stack Cost	Total Quantity	Total Cost	
Polar Samples	FO/001	Copper Foil	Copper	100-001	2	0.50	1.00	2	1.00	
Polar Samples	PP/007	PrePreg 1651	Dielectric	300-004	6	1.00	6.00	6	6.00	
Polar Samples	PP/002	PrePreg 3080	Dielectric	300-002	3	1.00	3.00	3	3.00	
Polar Samples	PP/001	PrePreg 1080	Dielectric	300-001	2	1.00	2.00	2	2.00	
Polar Samples	FO/002	Copper Foil	Copper	100-002	2	2.00	4.00	2	4.00	
Polar Samples	PP/003	PrePreg 3113	Dielectric	300-003	2	1.00	2.00	2	2.00	
Polar Samples	CO/008	FR4 Core	FR4	400-008	1	2.00	2.00	1	2.00	
							23.00		23.00	

No. of Panels = 1 | Circuits Per Panel = 1 | Price Per Circuit = 23.00 |
Notes

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